































Two-Step Diffusion

- Two step diffusion procedure:
 - ♦ Step 1: predeposition (i.e., constant source diffusion)
- \$\frac{5\tep 2}{\text{step 2}}: drive-in diffusion (i.e., limited source diffusion)
- For processes where there is both a predeposition and a drive-in diffusion, the final profile type (i.e., complementary error function or Gaussian) is determined by which has the much greater Dt product:

 $(Dt)_{predep} \gg (Dt)_{drive-in} \Rightarrow impurity profile is complementary error function$

 $(Dt)_{drive-in} \gg (Dt)_{predep} \Rightarrow impurity profile is Gaussian (which is usually the case)$

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Successive Diffusions

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- For actual processes, the junction/diffusion formation is only one of many high temperature steps, each of which contributes to the final junction profile
- Typical overall process:
 - 1. Selective doping
 - Implant \rightarrow effective (Dt)₁ = $(\Delta R_p)^2/2$ (Gaussian)
 - Drive-in/activation $\rightarrow D_2 t_2$
 - 2. Other high temperature steps
 - (eg., oxidation, reflow, deposition) $\rightarrow D_3t_3$, D_4t_4 , ...
 - ◆ Each has their own Dt product
 - 3. Then, to find the final profile, use

$$(Dt)_{tot} = \sum_{i} D_{i} t_{i}$$

in the Gaussian distribution expression.

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The Diffusion Coefficient $D = D_o \exp \left(-\frac{E_A}{kT} \right) \text{ (as usual, an Arrhenius relationship)}$ $\frac{\text{Table 4.1 Typical Diffusion Coefficient Values for a Number of Impurities.}}{Element}$ $\frac{D_o(\text{cm}^2/\text{sec})}{B}$ $\frac{E_A(\text{eV})}{B}$ $\frac{10.5}{B}$

Element	$D_0(\text{cm}^2/\text{sec})$	$E_{A}(eV)$
В	10.5	3.69
Al	8.00	3.47
Ga	3.60	3.51
In	16.5	3.90
P	10.5	3.69
As	0.32	3.56
Sb	5.60	3.95















